

January 2010

FDC642P

Single P-Channel 2.5V Specified PowerTrench® MOSFET -20 V, -4.0 A, 65 m Ω

Features

- Max $r_{DS(on)} = 65 \text{ m}\Omega$ at $V_{GS} = -4.5 \text{ V}$, $I_D = -4.0 \text{ A}$
- Max $r_{DS(on)}$ = 100 m Ω at V_{GS} = -2.5 V, I_D = -3.2 A
- Fast switching speed
- Low gate charge (11nC typical)
- High performance trench technology for extremely low r_{DS(on)}
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1 mm thick)
- Termination is Lead-free and RoHS Compliant



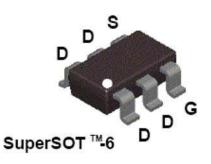
General Description

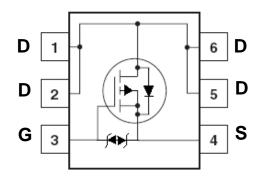
This P-Channel 2.5V specified MOSFET is produced using Fairchild's advanced PowerTrench® process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the larger packages are impractical.

Applications

- Load switch
- Battery protection
- Power management





MOSFET Maximum Ratings T_C = 25℃ unless otherwise noted

Symbol	Param		Ratings	Units	
V _{DS}	Drain to Source Voltage			-20	V
V _{GS}	Gate to Source Voltage			±8	V
1	-Continuous	T _A = 25℃	(Note 1a)	-4.0	۸
'D	-Pulsed			-20	A
D	Power Dissipation		(Note 1a)	1.6	W
P_{D}	Power Dissipation		(Note 1b)	0.8	VV
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to + 150	C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	€/W

Package Marking and Ordering Information

Device Marking	Device	Package	Package Reel Size Tape Wid		Quantity
.642	FDC642P	SSOT-6 TM	7 " 8 mm		3000 units

Electrical Characteristics $T_J = 25\%$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-20			V
$\frac{\Delta BV_{DS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = -250 μA, referenced to 25℃		-13		mV /°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-0.4	-0.6	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = -250 μA, referenced to 25℃		2.5		mV/℃
		$V_{GS} = -4.5 \text{ V}, I_D = -4.0 \text{ A}$		45	65	
rno()	Static Drain to Source On Resistance	$V_{GS} = -2.5 \text{ V}, I_D = -3.2 \text{ A}$		55	100	mΩ
r _{DS(on)}	Static Brain to Source On Resistance	$V_{GS} = -4.5 \text{ V, } I_{D} = -4.0 \text{ A,}$ $T_{J} = 125 ^{\circ}\text{C}$		62	90	11152
9 _{FS}	Forward Transconductance	$V_{DS} = -5 \text{ V}, I_{D} = -4.0 \text{ A}$		15		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 10 V V 0 V	700	925	pF
C _{oss}	Output Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz	110	150	pF
C _{rss}	Reverse Transfer Capacitance	- 1 101112	95	145	pF

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		6	12	ns
t _r	Rise Time	$V_{DD} = -10 \text{ V, } I_{D} = -1 \text{ A,}$	7	14	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = -4.5 V, R_{GEN} = 6 Ω	120	190	ns
t _f	Fall Time		52	83	ns
Q_g	Total Gate Charge	V 40.V I 4.A	11	16	nC
Q_{gs}	Gate to Source Charge	$V_{DD} = -10 \text{ V}, I_{D} = -4 \text{ A}$ $V_{GS} =4.5 \text{ V}$	1.1		nC
Q_{qd}	Gate to Drain "Miller" Charge	v _{GS} =4.5 v	3.0		nC

Drain-Source Diode Characteristics

I_S	Maximum Continuous Drain-Source Diode Forward Current			-1.3	Α	
V_{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -1.3 \text{ A}$	(Note 2)	-0.7	-1.2	V

Notes

^{1:} R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.

a. 78 °C/W when mounted on a 1 in $^{\rm 2}$ pad of 2 oz copper.

b. 156 $\mbox{\ensuremath{\mbox{$\mathfrak{C}$/W}$}}$ when mounted on a minimum pad of 2 oz copper.

^{2:} Pulse Test: Pulse Width<300 us, Duty Cycle<2.0%.

Typical Characteristics T_J = 25℃ unless otherwise noted

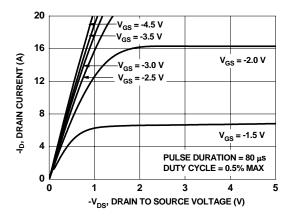


Figure 1. On Region Characteristics

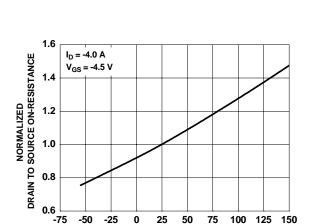


Figure 3. Normalized On Resistance vs Junction Temperature

T_J, JUNCTION TEMPERATURE (°C)

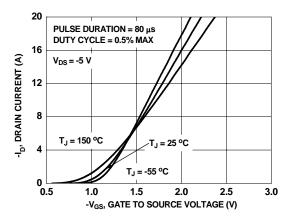


Figure 5. Transfer Characteristics

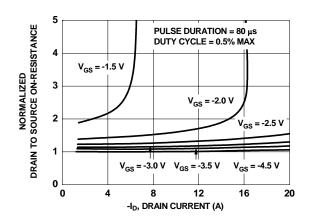


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

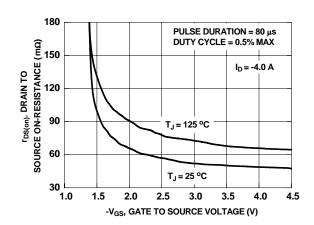


Figure 4. On-Resistance vs Gate to Source Voltage

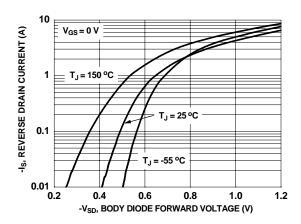


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25℃ unless otherwise noted

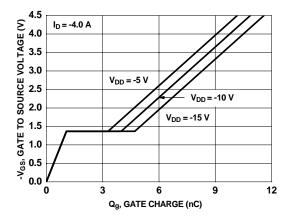


Figure 7. Gate Charge Characteristics

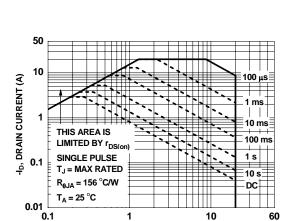


Figure 9. Forward Bias Safe Operating Area

-V_{DS}, DRAIN to SOURCE VOLTAGE (V)

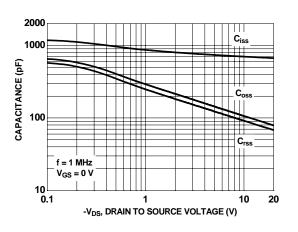


Figure 8. Capacitance vs Drain to Source Voltage

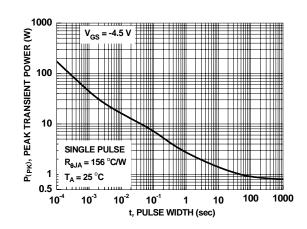


Figure 10. Single Pulse Maximum Power Dissipation

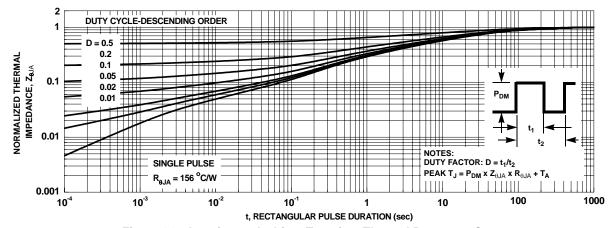


Figure 11. Junction-to-Ambient Transient Thermal Response Curve





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